



General Description

XC6202Pxx2MR-G series a set of Low Dropout Linear Regulator ICs implemented in CMOS technology. They can withstand voltage 20V. And they are available with lowvoltage drop and low quiescent current, widely used in audio, video and communication appliances.

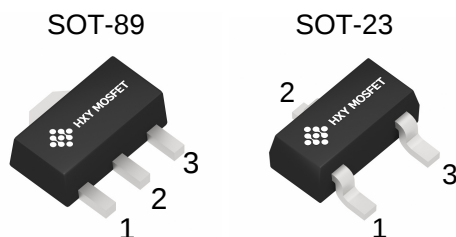
Features

- Low Power Consumption
- Low Voltage Drop
- Low Temperature Coefficient
- Withstanding Voltage 20V
- Quiescent Current 2.0 μ A
- Output Voltage Accuracy: tolerance $\pm 2\%$
- High output current: 150mA

Application

- Battery-powered Equipments
- Communication Equipments
- Audio/Video Equipments

Pin Configuration And Descriptions



No.	Name	Functions Description
1	GND	Ground
2	V _{IN}	Input
3	V _{OUT}	Output

Order Information

Orderable Device	Package	Output Voltage	Packing Option
XC6202Pxx2MR-G	SOT-23	3.0V,3.3V,5.0V	3000/Reel
XC6202Pxx2PR-G	SOT-89	3.0V,3.3V,5.0V	1000/Reel

Note: xx is 30,33,50



Absolute Maximum Ratings

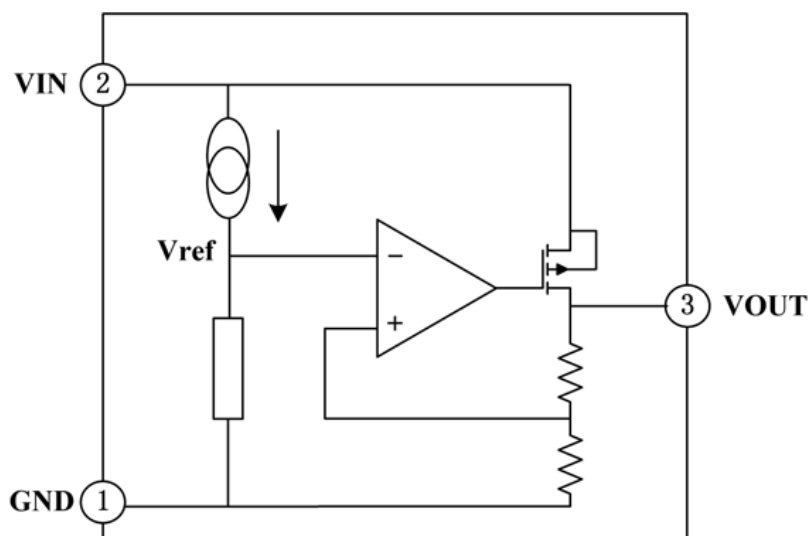
Description	Symbol	Value Range	Unit
Limit Power Voltage	V_{IN}	-0.3~+24	V
Storage Temperature Range	T_{STG}	-50~+125	°C
Operating Free-air Temperature Range	T_A	-40~+85	°C

Note: Stresses greater than those listed under “Absolute Maximum Ratings” cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “Recommended Operating Conditions” is not implied. Exposure to “Absolute Maximum Ratings” for extended periods may affect device reliability.

Heat Dissipation

Description	Symbol	Package	Value Range	Unit
Thermal resistance	θ_{JA}	SOT-89	200	°C/W
		SOT-23	500	°C/W
Power dissipation	P_W	SOT-89	500	mW
		SOT-23	200	mW

Block Diagram





DC Characteristics (unless otherwise noted $T_A = 25^\circ\text{C}$)

XC6202P302MR-G

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN} = V_{OUT} + 2.0V$, $I_{OUT} = 10mA$	2.94	3.0	3.06	V
Output Current	I_{OUT}	$V_{IN} = V_{OUT} + 2.0V$	150			mA
Load Regulation	ΔV_{OUT}	$V_{IN} = V_{OUT} + 2.0V$ $1mA \leq I_{OUT} \leq 150mA$		37	100	mV
Voltage Drop	V_{DIF}	$I_{OUT} = 100mA$, $\Delta V_{OUT} = 2\%$		210	300	mV
Quiescent Current	I_{SS}	NoLoad		1.5	3.0	μA
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT}} \cdot \Delta V_{IN}$	$V_{OUT} + 1.0V \leq V_{IN} \leq 20V$, $I_{OUT} = 1mA$			0.2	%/V
Input Voltage	V_{IN}				20	V
Temperature Coefficient	$\frac{\Delta V_{OUT}}{\Delta T_A} \cdot V_{OUT}$	$V_{IN} = V_{OUT} + 2.0V$, $I_{OUT} = 10mA$, $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$		± 100		ppm/ $^\circ\text{C}$
Overcurrent Protection	I_{lim}	$V_{OUT} = 0V$		400		mA

Note: When $V_{IN} = V_{OUT} + 2.0V$, as the output voltage declined 2%, the $V_{DIF} = V_{IN} - V_{OUT}$.

XC6202P332MR-G

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN} = V_{OUT} + 2.0V$, $I_{OUT} = 10mA$	3.234	3.3	3.366	V
Output Current	I_{OUT}	$V_{IN} = V_{OUT} + 2.0V$	150			mA
Load Regulation	ΔV_{OUT}	$V_{IN} = V_{OUT} + 2.0V$ $1mA \leq I_{OUT} \leq 150mA$		37	100	mV
Voltage Drop	V_{DIF}	$I_{OUT} = 100mA$, $\Delta V_{OUT} = 2\%$		195	300	mV
Quiescent Current	I_{SS}	NoLoad		1.5	3.0	μA
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT}} \cdot \Delta V_{IN}$	$V_{OUT} + 1.0V \leq V_{IN} \leq 20V$, $I_{OUT} = 1mA$			0.2	%/V
Input Voltage	V_{IN}				20	V
Temperature Coefficient	$\frac{\Delta V_{OUT}}{\Delta T_A} \cdot V_{OUT}$	$V_{IN} = V_{OUT} + 2.0V$, $I_{OUT} = 10mA$, $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$		± 100		ppm/ $^\circ\text{C}$
Overcurrent Protection	I_{lim}	$V_{OUT} = 0V$		400		mA

Note: When $V_{IN} = V_{OUT} + 2.0V$, as the output voltage declined 2%, the $V_{DIF} = V_{IN} - V_{OUT}$.



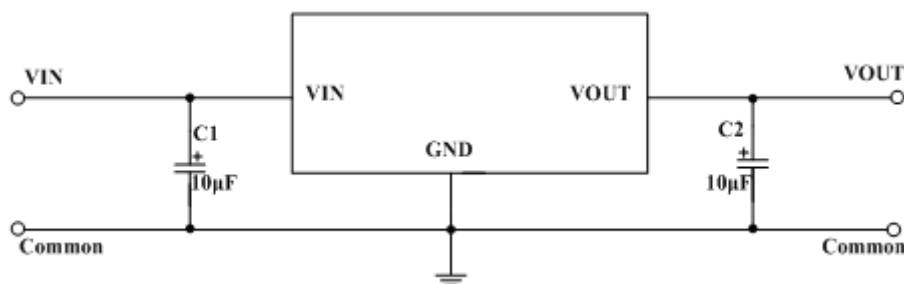
XC6202P502MR-G

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output Voltage	V_{OUT}	$V_{IN}=V_{OUT}+2.0V$, $I_{OUT}=10mA$	4.9	5.0	5.1	V
Output Current	I_{OUT}	$V_{IN}=V_{OUT}+2.0V$	200			mA
Load Regulation	ΔV_{OUT}	$V_{IN}=V_{OUT}+2.0V$ $1mA \leq I_{OUT} \leq 150mA$		37	100	mV
Voltage Drop	V_{DIF}	$I_{OUT}=100mA$, $\Delta V_{OUT}=2\%$			300	mV
Quiescent Current	I_{SS}	NoLoad		1.5	3.0	μA
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT}} \cdot \Delta V_{IN}$	$V_{OUT}+1.0V \leq V_{IN} \leq 20V$, $I_{OUT}=1mA$			0.2	%/V
Input Voltage	V_{IN}				20	V
Temperature Coefficient	$\frac{\Delta V_{OUT}}{\Delta T_A} \cdot V_{OUT}$	$V_{IN}=V_{OUT}+2.0V$, $I_{OUT}=10mA$, $-40^{\circ}C \leq T_A \leq 85^{\circ}C$		± 100		ppm/ $^{\circ}C$
Overcurrent Protection	I_{lim}	$V_{OUT}=0V$		400		mA

Note:When $V_{IN}=V_{OUT}+2.0V$,as the output voltage declined 2%,the $V_{DIF}=V_{IN}-V_{OUT}$.

Application Circuit

Basic Circuits





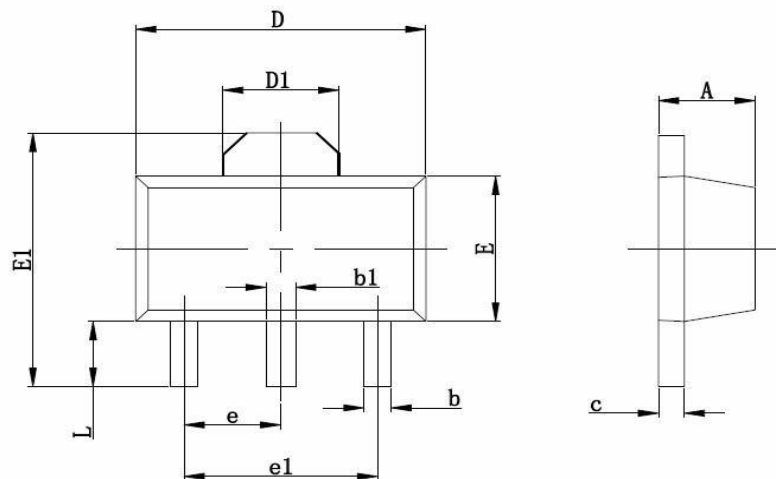
Function Description

XC6202Pxx2MR-G series are linear voltage regulator ICs withstanding 20V voltage. The series IC consists of a voltage reference, an error amplifier, a current limiter and a phase compensation circuit plus a driver transistor. The output stabilization capacitor is also compatible with low ESR ceramic capacitors.

The over current protection circuit and the over voltage protection circuit are built-in. The protection circuit will operate when the output current or input voltage reaches limit level.



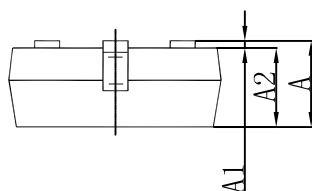
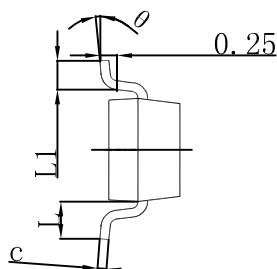
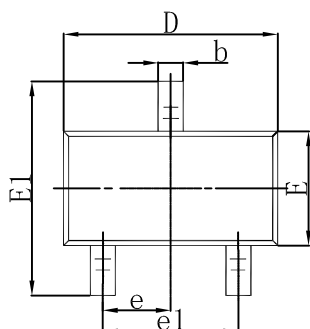
SOT-89 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF.		0.061 REF.	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP.		0.060 TYP.	
e1	3.000 TYP.		0.118 TYP.	
L	0.900	1.200	0.035	0.047

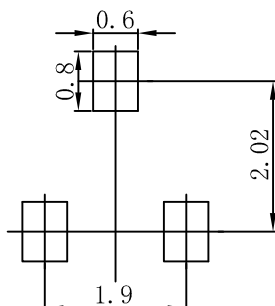


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



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